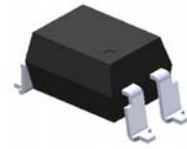


**Description**

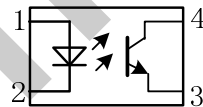
The 817 series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector encapsulated with green compound. The devices are in a 4-pin DIP package and available in wide-lead spacing and SMD option.



**Features**

- ◆ Current transfer ratio(CTR: 50~600% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$ )
- ◆ High isolation voltage between input and output ( $V_{ISO} = 5000\text{ V rms}$ )
- ◆ Creepage distance  $> 7.62\text{ mm}$ .
- ◆ Operating temperature up to  $+110^\circ\text{C}$
- ◆ Compact small outline package
- ◆ Pb free and RoHS compliant.

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

**Applications**

- ◆ Programmable controllers.
- ◆ System appliances, measuring instruments.
- ◆ Telecommunication equipments.
- ◆ Home appliances, such as fan heaters, etc.
- ◆ Signal transmission between circuits of different potentials and impedances.

**Absolute maximum ratings** ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Rating	Unit	
Input	Forward current	$I_F$	50	mA
	Reverse voltage	$V_R$	6	V
	Power dissipation Derating factor (above $T_a = 100^\circ\text{C}$ )	$P_D$	70 2.9	mW mW/ $^\circ\text{C}$
Output	Power dissipation 150 mW Derating factor (above $T_a = 100^\circ\text{C}$ )	$P_C$	150 5.8	mW mW/ $^\circ\text{C}$
	Collector current	$I_C$	50	mA
	Collector-Emitter voltage	$V_{CEO}$	35	V
	Emitter-Collector voltage	$V_{ECO}$	6	V
	Total power dissipation	$P_{TOT}$	200	mW
Isolation voltage <sup>*1</sup>	$V_{ISO}$	5000	V rms	
Operating temperature	$T_{opr}$	-40~+110	$^\circ\text{C}$	
Storage temperature	$T_{stg}$	-55~+125	$^\circ\text{C}$	
Soldering temperature <sup>*2</sup>	$T_{sol}$	260	$^\circ\text{C}$	

### Notes

- 1.AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together.
- 2.For 10 seconds

### Electrical characteristics (Ta=25°C unless specified otherwise)

#### Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Reverse current	I <sub>R</sub>	-		10	uA	V <sub>R</sub> = 4V
Input capacitance	C <sub>t</sub>		30	250	pF	V = 0, f = 1kHz

#### Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Collector-Emitter darkcurrent	I <sub>CEO</sub>	-	-	100	nA	V <sub>CE</sub> = 20V, I <sub>F</sub> = 0mA
Collector-Emitter breakdown voltage	BV <sub>CEO</sub>	35	-	-	V	I <sub>C</sub> = 0.1mA
Emitter-Collector breakdown voltage	BV <sub>ECO</sub>	6	-	-	V	I <sub>E</sub> = 0.1mA

### Transfer characteristics (Ta=25°C unless specified otherwise)

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Current Transfer ratio	817	50	-	600	%	I <sub>F</sub> = 5mA, V <sub>CE</sub> = 5V
	817A	80	-	160		
	817B	130	-	260		
	817C	200	-	400		
	817D	300	-	600		
	817L	50	-	100		
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>		0.1	0.2	V	I <sub>F</sub> = 20mA, I <sub>C</sub> = 1mA
Isolation resistance	R <sub>ISO</sub>	5×10 <sup>10</sup>			Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H
Floating capacitance	C <sub>f</sub>		0.6	1.0	pF	V <sub>IO</sub> = 0, f = 1MHz
Cut-off frequency	f <sub>c</sub>		35		kHz	V <sub>CE</sub> = 5V, I <sub>C</sub> = 2mA R <sub>L</sub> = 100Ω, -3dB
Rise time	t <sub>r</sub>		4	18	μs	V <sub>CE</sub> = 2V, I <sub>C</sub> = 2mA, R <sub>L</sub> = 100Ω
Fall time	t <sub>f</sub>		3	18	μs	

Typical values at Ta = 25°C

**Typical Performance Curves**

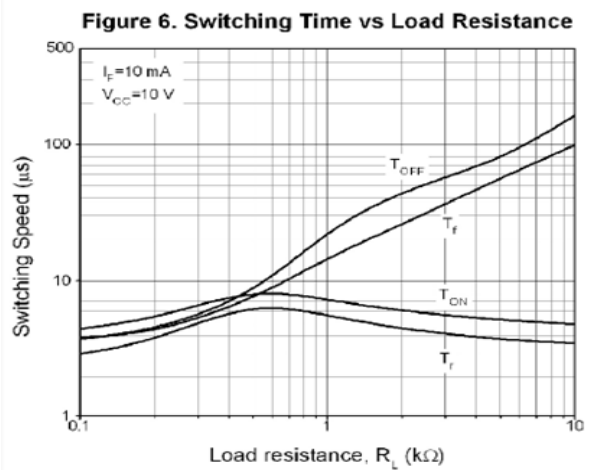
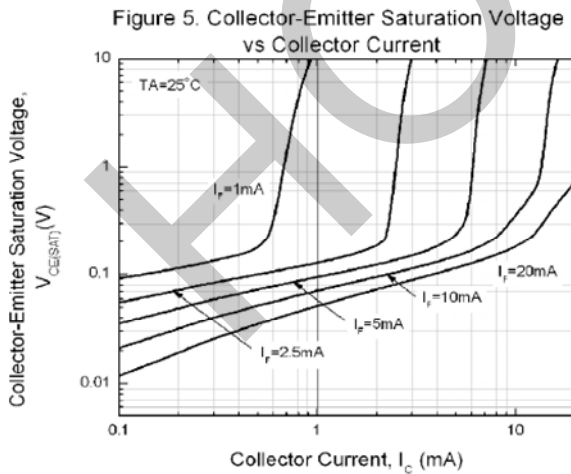
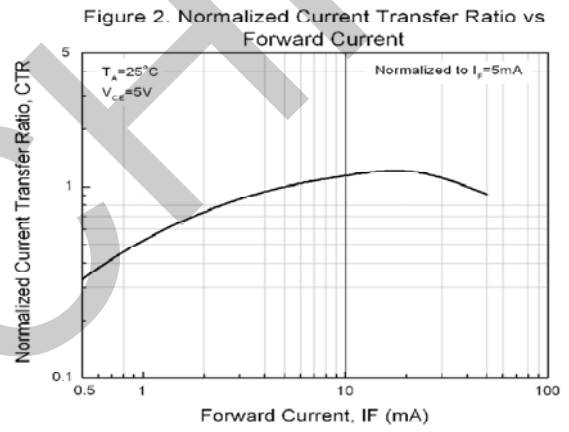
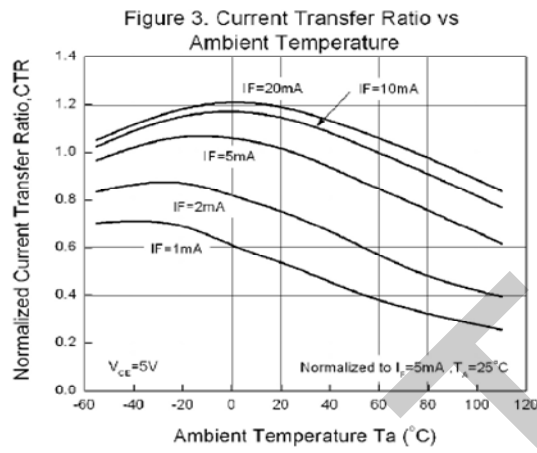
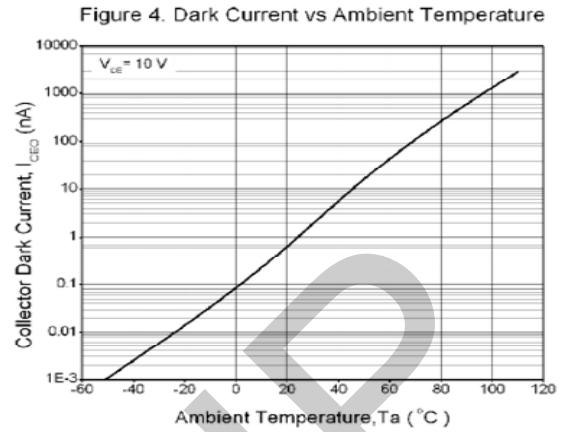
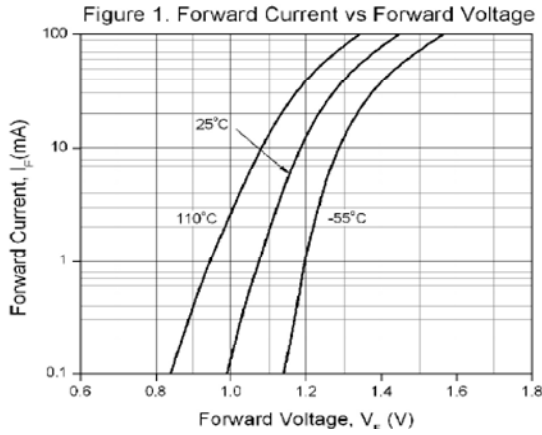
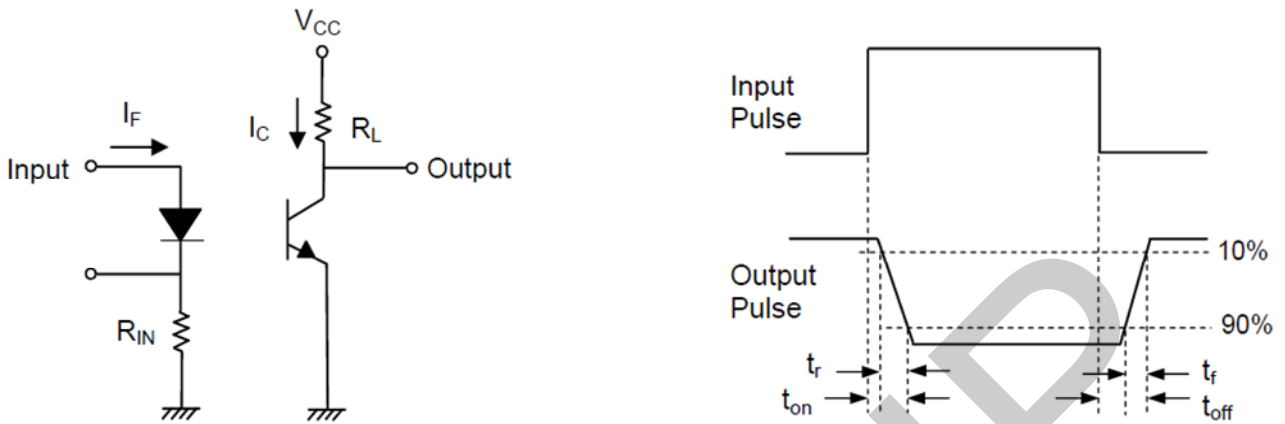
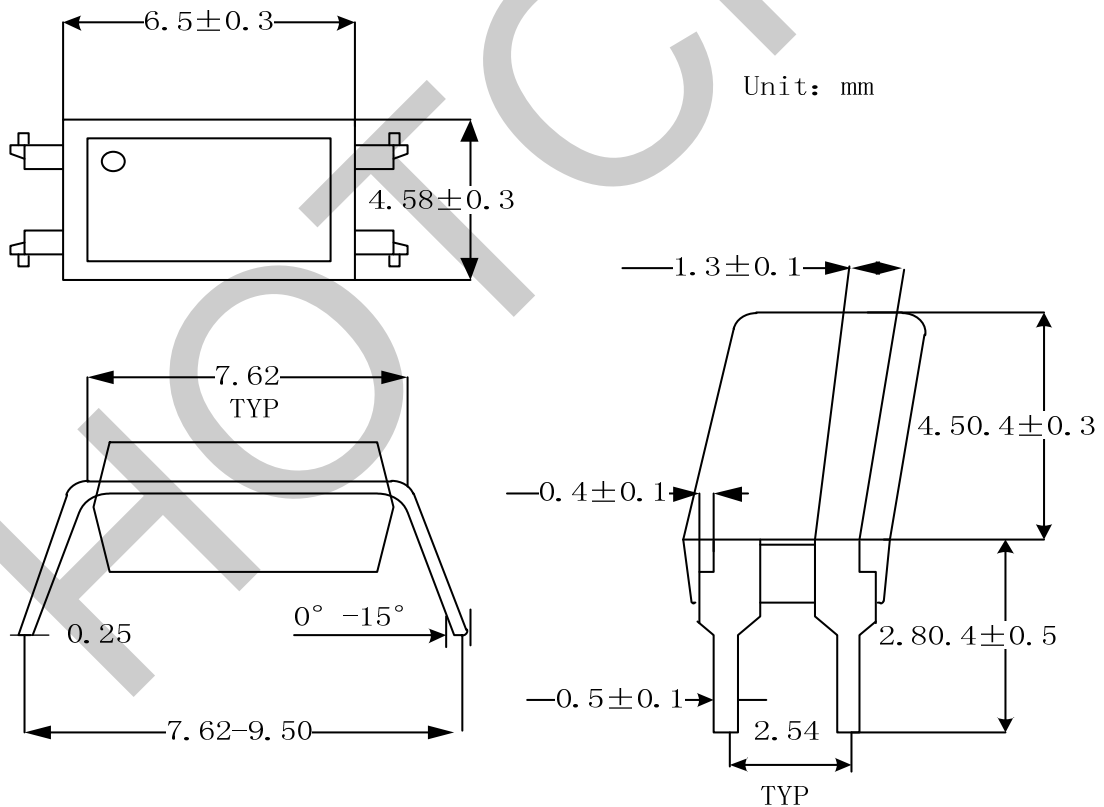


Figure:7. Switching Time Test Circuit & Waveforms



**Package Drawing(Dimensions in mm)**

Standard DIP Type



**Option SOT Type**